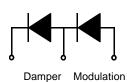


## FFPF60B150DS

#### **Features**

- · High voltage and high reliability
- High speed switching Modulation diode / Damper diode
- Low conduction loss Modulation diode / Damper diode





## **Applications**

 (Modulation + Damper) diode designed for horizontal deflection circuits in C-TVs & monitors

## **DAMPER + MODULATION DIODE**

### Absolute Maximum Ratings (Modulation) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	600	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	20	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	120	Α
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

## Absolute Maximum Ratings (Damper) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	1500	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	6	А
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	60	Α
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.3	°C/W

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# Electrical Characteristics\*(Modulation) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter			Тур.	Max.	Units
$V_{FM}$	Maximum Instantaneous Forward Voltage					V
	I <sub>F</sub> = 20A I <sub>F</sub> = 20A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C			2.2	
	·	1 <sub>C</sub> = 100 °C			2.0	^
IRM	Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C			10	μΑ
	Maximum Dayaraa Dagayan Tima	1 <sub>C</sub> = 100 °C			100	
t <sub>rr</sub> I <sub>rr</sub>	Maximum Reverse Recovery Time Maximum Reverse Recovery Current				90 8	ns A
Q <sub>rr</sub>	Maximum Reverse Recovery Charge (I <sub>F</sub> =20A, di/dt = 200A/μs)				360	nC

 $<sup>^{\</sup>star}$  Pulse Test: Pulse Width=300µs, Duty Cycle=2%

## Electrical Characteristics\*(Damper) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter		Min	Тур	Max	Units
V <sub>FM</sub>	Maximum Instantaneous Forward Voltage					V
	I <sub>F</sub> = 6A I <sub>F</sub> = 6A	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$			1.6 1.4	
I <sub>RM</sub>	Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C			7 60	μΑ
t <sub>rr</sub>	Maximum Reverse Recovery Time (I <sub>F</sub> =1.0A, di/dt = 50A/μs)				170	ns
t <sub>fr</sub>	Maximum Forward Recovery Time (I <sub>F</sub> =6.5A, di/dt = 50A/μs)				350	ns
$V_{FRM}$	Maximum Forward Recovery Voltage				17	V

 $<sup>^{\</sup>star}$  Pulse Test: Pulse Width=300 $\mu s,$  Duty Cycle=2%

# **Typical Characteristics**

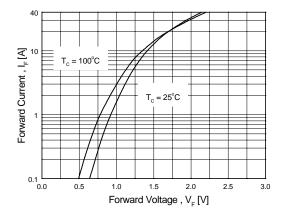


Figure 1. Typical Forward Characteristics (Modulation Diode)

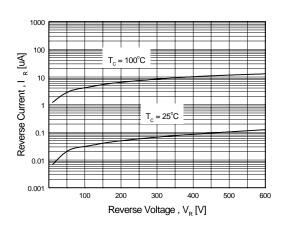


Figure 3. Typical Reverse Current vs. Reverse Voltage (Modulation Diode)

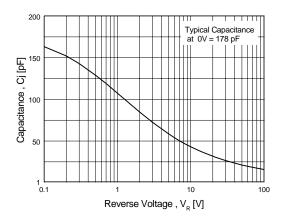


Figure 5. Typical Junction Capacitance (Modulation Diode)

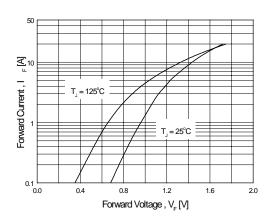


Figure 2. Typical Forward Characteristics (Damper Diode)

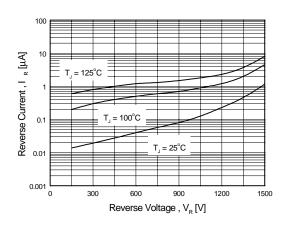


Figure 4. Typical Reverse Current vs. Reverse Voltage (Damper Diode)

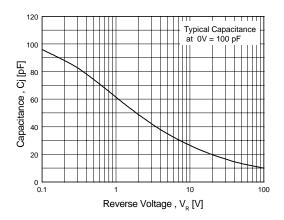


Figure 6. Typical Junction Capacitance (Damper Diode)

# **Typical Characteristics**

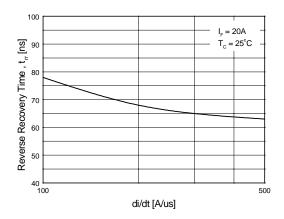


Figure 7. Typical Reverse Recovery Time vs. di/dt (Modulation Diode)

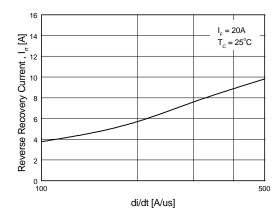


Figure 9. Typical Reverse Recovery Current vs. di/dt (Modulation Diode)

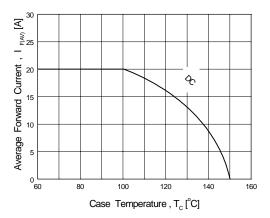


Figure 11. Forward Current Derating Curve (Modulation Diode)

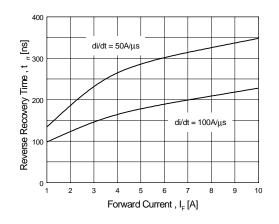


Figure 8. Typical Reverse Recovery Time vs. di/dt (Damper Diode)

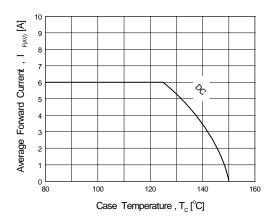
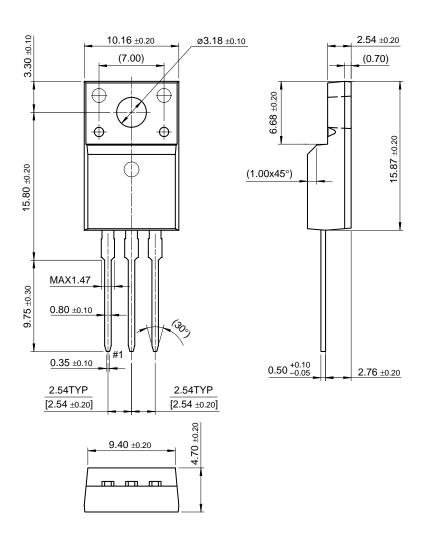


Figure 10. Forward Current Derating Curve (Damper Diode)

# **Package Dimensions**

# TO-220F



Dimensions in Millimeters

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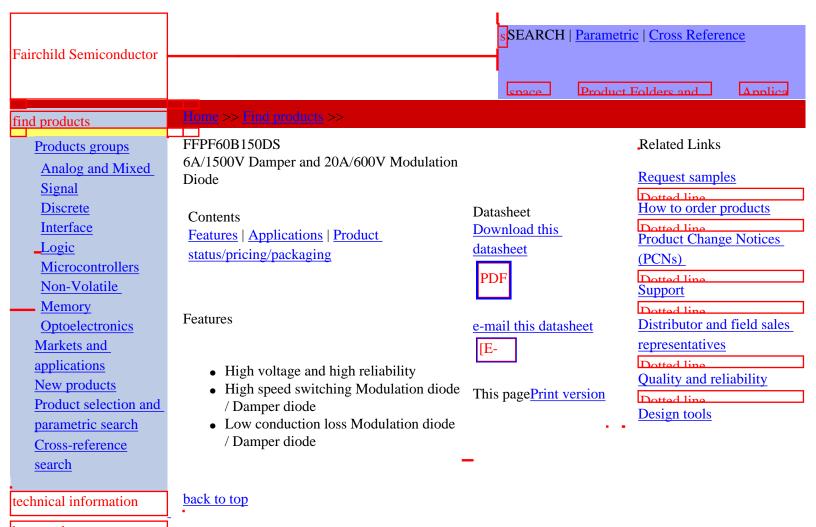
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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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### Applications

 (Modulation + Damper) diode designed for horizontal deflection circuits in C-TVs & monitors

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
FFPF60B150DSTU	Full Production	\$0.89	<u>TO-220F</u>	3	RAIL

<sup>\* 1,000</sup> piece Budgetary Pricing

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